製品規格 承認願 Qualification of Products Approval

<u>To</u>: ㈜피에스티

製品名 Product	Bluetooth Antenna	
型 名 Type	ALA 931C5	
申 請 日 Date	2007. 03. 16	



SEJONG TRONICS CO., LTD

Rm. 1216 Korea-Business 1338-21 Seocho-dong, Seocho-gu, SEOUL, KOREA TEL: 82)2-586-6012 FAX: 82)2-586-6082

APPROVAL SHEET

Type: Multilayer Chip Antenna

Part No.: ALA931C5

Check	Consent	Approval



	Written	Che	ecked	Approved
Amotech	Total Processing	M2	- phohee	Aus)
	12/18	12/18.	12/18	12/18

2007. 3. 16

AMOTECH Co., Ltd.

Content

1.	Revision History	••••••	3
2.	Specifications	••••••	4
	2.1 Electrical Specifications	S	
	2.2 Mechanical Specification	ons	
	2.3 Index method of Part N	o. & Lot No.	
3.	Test Method	••••••	6
	3.1 VSWR		
	3.2 Radiation Gain		
4.	Reliability Test	•••••••	7
5.	Soldering Recommend	••••••	8
	5.1 Reflow profile for Pb-fre	ее	
	5.2 PCB land pattern		
6.	Structure and Material	•••••••••••	9
	6.1 Material		
	6.2 Equivalent symbol		
7.	Cautions	••••••	10
8.	Packing Method	••••••	10
	8.1 Carrier-tape		
	8.2 Reel		
0	8.3 Packing box	•••••	12
9	Manufacture & Place		1/

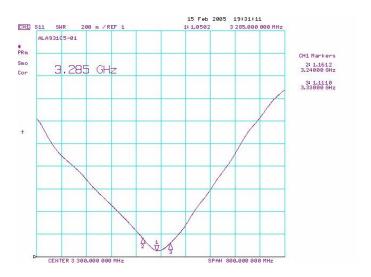
1. Revision Record

Date	Title	Content	Remark
2006.12.18		New drawing up	

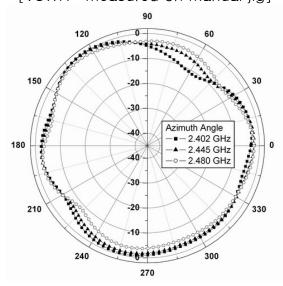
2. Specifications

2.1 Electrical specifications

No	Item	Spec.	Remark
1	Frequency Range	2400~2500	ISM Band
2	VSWR	Max. 3.0:1 @3285±45 MHz	On manual jig
3	Radiation Gain	Max. 0 dBi @azimuth co-pol.	Measured after matching on testboard
4	Radiation Pattern	Omni-directional	
5	Impedance	Nominal 50 Ω	



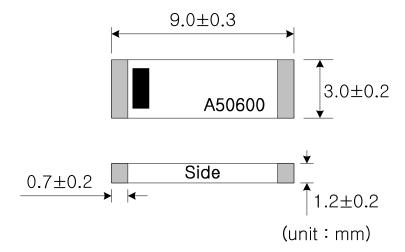
[VSWR: measured on manual jig]



[Radiation Gain: Measured on Ref. Board]

2.2 Mechanical specifications

No	Item		Spec.	Unit
		W	9.0 ± 0.3	
1	Dimensions	D	3.0 ±0.2	mm
		Н	1.2 ±0.2	
2	Unit Weight		97± 9	mg
3	Operation Temp.	−30 ~ +70		$^{\circ}$
4	Storage Temp.	−40 ~ +85		$^{\circ}$



[Chip Antenna dimension]

2.3 Index method of Part No. & Lot No.

Davit N.	ALA	931	<u>C5</u>
Part No.	(1)	(2)	(3)

(1): Amotech Antenna

(2): Chip size

(3): Version & frequency

Lot No.
$$\frac{MA}{(1)}$$
 $\frac{09}{(2)}$ $\frac{A5}{(3)}$ $\frac{0506}{(4)}$ $\frac{01}{(5)}$

(1): Mass product Antenna

(2): Chip size

(3): Version & frequency

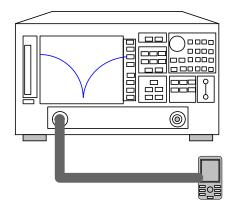
(4): Y/M

(5): Serial No. of product

3. Test Method

3.1 VSWR

Equipment: Network Analyzer 8753ES

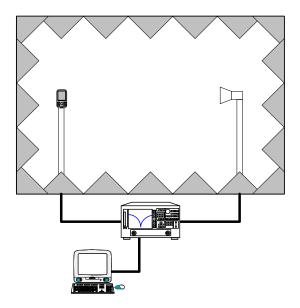


[Test procedure]

- a Setup as shown picture.
- ⓑ Calibrate Network Analyzer in frequency range of $f_0\pm 400$ MHz, verify that the value of return loss(S_{11}) is under -55dB with termination(50ohm)
- © After connect a mobile set or manual jig for single chip antenna to Network Analyzer, measure the max. value of VSWR in frequency range of spec.

3.2 Radiation gain

Equipment: Anechoic chamber, Network Analyzer 8753ES



[Test procedure]

- (a) Calibrate network analyzer and anechoic chamber using reference horn antenna.
- (b) Set-up operation software (frequency, angle step, etc.)
- © After connecting AUT on holder, measure radiation gain.

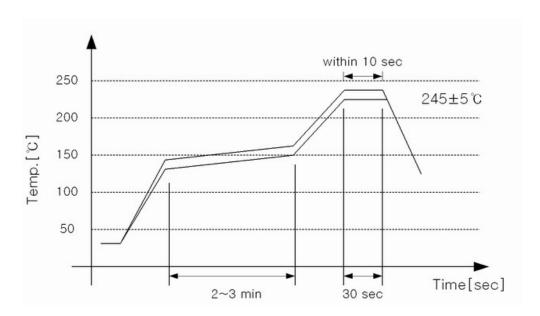


4. Reliability Test

No	ITEM	TEST CONDITION	TEST REQUIREMENTS
1	Adhesive Strength of Termination	1. Applied force on SMD chip till detached point from PCB.	 No mechanical damage by forces applied on the right. Strength (F) > 7 kgf
2	Tensile Strength	1. Wire : 0.6~0.8 tined Cu wire Wire — Clamp	No mechanical damage by forces applied on the right. Strength (F) > 3 kgf
3	Thermal Shock (Temperature Cycle)	1. 1 cycle / step 1: -40 ± 3°C, 30 min step 2: +125 ± 3°C, 30 min 2. Number of cycle: 30 3. Measure after left for 48 hrs min. at room temperature	No visual damage Within electric spec (VSWR)
4	High Temperature Resistance	 Temperature: +125 ± 5 °C Time: 1000 ± 24 hrs Measure f_C after left for 24 hrs min. at room temperature 	No visual damage Within electric spec (VSWR)
5	Low Temperature Resistance	1. Temperature : -40 \pm 5 $^{\circ}$ C 2. Time : 1000 \pm 24 hrs 3. Measure f _C after left for 48 hrs min. at room temperature	No visual damage Within electric spec (VSWR)
6	Humidity (Steady Condition)	 Humidity: 85 % RH Temperature: +85 ± 3 °C Time: 1000 ± 24 hrs Measure f_C after left for 48 hrs min. at room temperature 	No visual damage Within electric spec (VSWR)

5. Soldering Recommend

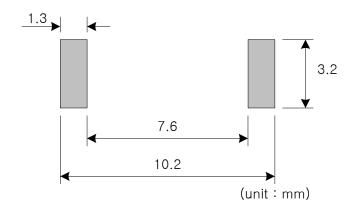
5.1 Reflow profile for Pb-free



This product is designed for reflow soldering only. Do not use flow (wave) soldering.

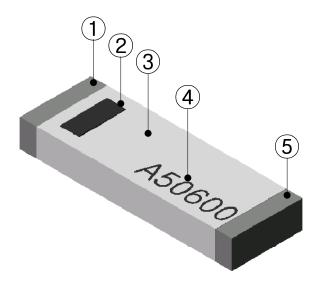
- ① Use non-activated flux (CI content 0.2% max.)
- 2 Follow the recommended soldering conditions to avoid damage.
- 3 Reflow-cycle is max. 3 times.

5.2 PCB land pattern



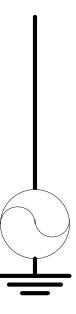
6. Structure and Material

6.1 Material



No	Part	Function	Material
1	External Electrode Soldering, Feeding		Ag/Ni/Sn
2	Direction Index	Feeding Index	Ceramic
3	Ceramic Body	_	Ceramic
4	Text	Part No. Index	Ceramic
5	External Electrode	Soldering	Ag/Ni/Sn

6.2 Equivalent symbol

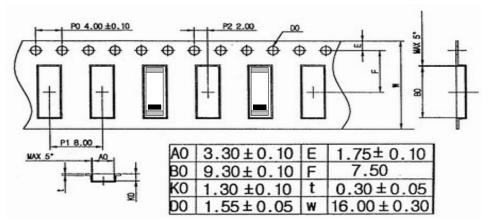


7. Cautions

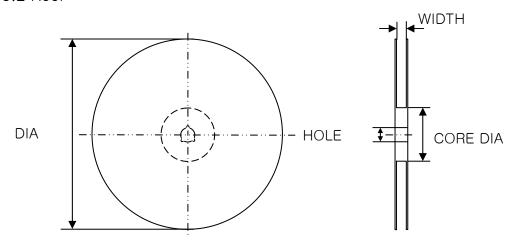
- ① Storage environment must be at ambient temperature of 15~35°C and ambient humidity of 45~75 % RH. (MSL Level 2)
- ② Chip antenna can experience degradation of termination solder ability when subjected to high temperature of humidity, or if exposed to sulfur or chlorine gases.
- 3 Avoid mechanical shock (ex. falling) to the chip antenna to prevent mechanical cracking inside of the ceramic dielectric due to its own weight.

8. Packing Method

8.1 Carrier-tape



8.2 Reel



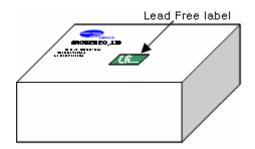
item	DIA	WIDTH	CORE DIA	HOLE
dimension(mm)	180.0 ± 0.3	17.0 ± 0.3	60.0 ± 1	13.0 ± 0.5

8.3 Packing box

8.3.1 Small box

Size: 185 (W) x 185 (D) x 68 (H) (mm)

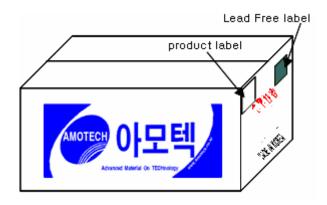
 $Q'TY : 3 \text{ reel } (1,000 \text{ ea/reel} \times 3 \text{ reel} = 3,000 \text{ ea})$



8.3.2 Middle box

Size: 365 (W) x 200 (D) x 200 (H) (mm)

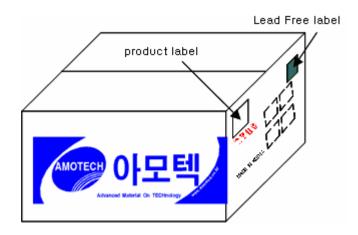
Q'TY: 5 small box(3,000 ea/small box \times 5 small box = 15,000 ea)



8.3.3 Large box

Size: 390 (W) x 390 (D) x 280 (H) (mm)

Q'TY: 14 small box(3,000 ea/ small box \times 14 small box = 42,000 ea)



9. Manufacture and Place

- 9.1 Manufacture
 Amotech Co., Ltd
- 9.2 Place5B 1L, Namdong Industrial Complex, 617 Namchondong, Namdonggu, Incheon, Korea



Test Report No. F690501/LF-CTSGP06-24480

To: AMOTECH CO., LTD.

5BL-1L, 617 Namchon-dong Namdong-gu INCHEON 405-100

Korea

The following merchandise was submitted and identified by the client as:

Commodity : Multilayer Chip Antenna

SGS File No. : GP06-24480

Received Date : September 18, 2006

Test Performing Date : September 19, 2006

Test Performed : SGS Testing Korea tested the sample(s) selected by applicant with following results

Test Results: For further details, please refer to following page(s)

SGS Testing Korea Co. Ltd.

Page 1 of 3

Date: September 25, 2006

Jade Jang Monet Jeong Jully Oh Jerry Jung /Testing Person

Jeff Jang / Chemical Lab Mgr



Test Report No. F690501/LF-CTSGP06-24480

Sample No. : GP06-24480.001

Sample Description : Multilayer Chip Antenna
Style/Item No. : Multilayer Chip Antenna

Heavy Metals

Test Items	Unit	Test Method	MDL	Results
Cadmium (Cd)	mg/kg	US EPA 3050B(1996), US EPA 6010B(1996), ICP	0.5	N.D.
Lead (Pb)	mg/kg	US EPA 3050B(1996), US EPA 6010B(1996), ICP	5	N.D.
Mercury (Hg)	mg/kg	US EPA 3052(1996), US EPA 6010B(1996), ICP	2	N.D.
Hexavalent Chromium (Cr VI)	mg/kg	US EPA 3060A(1996), US EPA 7196A(1992), UV	1	N.D.

Date: September 25, 2006

Page 2 of 3

Flame Retardants-PBBs/PBDEs

Test Items	Unit	Test Method	MDL	Results
Monobromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Dibromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Tribromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Tetrabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Pentabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Hexabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Heptabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Octabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Nonabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Decabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Monobromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Dibromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Tribromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Tetrabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Pentabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Hexabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Heptabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Octabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Nonabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Decabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.

NOTE: (1) N.D. = Not detected.(<MDL)

(2) ppm = mg/kg

(3) MDL = Method Detection Limit

(4) - = No regulation

(5) ** = Qualitative analysis (No Unit)

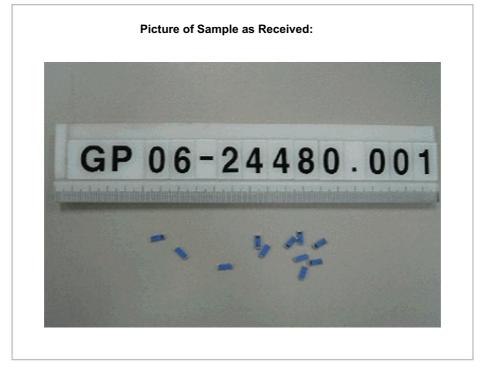
(6) Negative = Undetectable / Positive = Detectable

This Test Report is issued by the Company subject to its General Conditions of Service printed overleaf. Attention is drawn to the limitations of liability, indemnification and jurisdictional issues defined therein. The results shown in this test report refer only to the sample (s) tested unless otherwise stated. This Test Report cannot be reproduced, except in full, without prior written permission of the Company.



Test Report No. F690501/LF-CTSGP06-24480

Date: September 25, 2006 Page 3 of 3



*** End ***

NOTE: (1) N.D. = Not detected.(<MDL)

(2) ppm = mg/kg

(3) MDL = Method Detection Limit

(4) - = No regulation

(5) ** = Qualitative analysis (No Unit)

(6) Negative = Undetectable / Positive = Detectable

This Test Report is issued by the Company subject to its General Conditions of Service printed overleaf. Attention is drawn to the limitations of liability, indemnification and jurisdictional issues defined therein. The results shown in this test report refer only to the sample (s) tested unless otherwise stated. This Test Report cannot be reproduced, except in full, without prior written permission of the Company.